AS	PC SSOCIATION CONNECTING ECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannoc International and Pan-Americ	kburn, Illinois	. All rights reserve	tion with lower	level p	arts, the c	leclaratior	n encompa		r level mate	erials for	which the	item is an assembly e manufacturer has eclaration.		
1752-2 1.1 IPC Web Site for Informa http://www.ipc.org/IPC				tion on IPC-1752 Standard 175x							ation Class * 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat						
Sup	plier Information																
Company Name * C			Company Unique ID		Unique ID Au	nique ID Authority		Response Date *			Response Document ID						
SEMTECH CORPORATION SE			SEMTECH CORPOR	RATION		2016-11-03											
Contact Name *		Title - Contact		Phone - Contact *		Email - Contact *				Duralizata	Ocurtocat	۸ دار .	de al Das				
Elvia Finkel			Document, Control/C	ustomer S	805-498-2111		efinkel@semtech.com				Duplicate	Contact ·	-> Autho	rized Rep	presentative		
Authorized Representative		ve *	Title - Representative)	Phone - Representative *		Email - Representative *			* Sup	Supplier Comments or URL for Additional Information						
Elvia Finkel			Document, Control/C	Sustomer S	805-498-2111		efinkel@semtech.com										
Requester Item Number		r (Mfr Item Number		Mfr Item Name		Effective Date		Version	Manufactur	ing Site	Weight *	UC	M	Unit Type		
		GS3140-INE3			Multi-Rate Ad	daptive 3G SDI Equ					41		mg		Each		
	Alternate Recommendation					Alterna		Alternate	te Item Comments								
Ма	Manufacturing Process Information																
Terminal Plating / Grid Array Material		al	Terminal Base Alloy		J-STD-020 MSL Rating		ng Peak Process Body		Temperatur	ure Max Time at Peak Temp		perature	rature Number of Reflow Cy				
Matte Tin (Sn)				CU Alloy	oy 3			2			60 C		conds	3			
	iments 3140-INE3 is a REAC	H-con	npliant product, per	EU Regul	ation EC1907	7/2006 to include	recent	addition	of SVH0	C candida	e list of sub	ostances J	une 201	6			

Save the fields in this form to a file	Evport Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cupplier Fields
RoHS Materia	Composition Declar	ation				Declaration Type	* Detailed
		ty limit of 0.1% by mass (100 Ethers (PBDE) and quantity					ominated Biphenyls (PBB),
chromium, polybromina excess of an applicable gathered the information Company will rely on thi completing this form, ar certifications regarding conditions of that agree	ted biphenyls and/or polybrominate quantity limit, please indicate below it provides in this form using app s certification in determining the co d that Supplier may not have inde heir contributions to the part, and ment, including any warranty rights	ompliance of its products with European pendently verified such information. Ho those certifications are at least as comp	ricted substance?) in excess believe may apply. If the p y and that such information n Union member state laws owever, in situations where prehensive as the certificati hat agreement, will be the s	ss of the applicable quantity lim part is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independently ion in this paragraph. If the Co sole and exclusive source of the	it identified above. If a homoge evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges y verified information provided lo popany and the Supplier enter is a Supplier?s liability and the Co	eneous material within the part cor on shall encompass all such comp of the date that Supplier complete: s that Supplier may have relied on by others, Supplier agrees that, at into a written agreement with resp impany?s remedies for issues that	ntains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that information provided by others in a minimum, its suppliers have provided
RoHS Declaration	n * 1 - Item(s) does not conta	ain RoHS restricted substances per the	he definition above			Supplier Acceptance *	Accepted
	e declared item does not co all applicable exemptions.	ntain RoHS restricted substanc	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding re	esponse in the RoHS Declaration
Declaration S	ignature						
In a family of the second	ward a factor and the factor of the second s	al Calaba and all manages of the last		a second se		and the second s	terrestring and - Distingthe stars

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of		Level	Substance Category			Substance	CAS	Exempt	Weight		Tolerance		РРМ
	Name		Material	weight	Measure		Level	Substance Category			Substance		Exempt	weight	Measure	-	+	
+1 -1	Chip	+M -M		2.5	mg	+C -C	Supplier		+S ·	-s	Si	7440-21-3		2.5	mg			1,000,0
+I -I	Die Attach	+M -M	NEX-130CTX	1.5	mg	+C -C	Supplier		+S ·	-S	Bisphenol A Liquid Epo	25068-38-6		0.13	mg		;	8,500
						·			+S	-s	Specific Epoxy Resin	Trade Secre		0.26	mg			175,00
									+S	-s	Hardener	Trade Secre		0.04	mg			25,000
									+S	-s	Silica	60676-86-0,		0.98	mg			655,00
									+S	-s	Additives	Trade Secre		0.09	mg			60,000
+1 -1	Lead Finish Extern	a+M -M		0.4	mg	+C	Supplier		+S	-s	Tin(II) Methanesulphona	53408-94-9		0.2	mg		ļ	500,00
									+S	-s	Methane Sulfonic Acid	75-75-2		0.02	mg			50,000
									+S	-s	Water	7732-18-5		0.18	mg			450,00
+1 -1	Leadframe	+M -M	C194	15	mg	+C	Supplier		+S	-s	Fe	7439-89-6		0.35	mg		:	23,500
									+S	-s	Р	7723-14-0		0.01	mg			700
									+S	-S	Zn	7440-66-6		0.02	mg			1,200
									+S	-S	Cu	7440-50-8		14.37	mg			959,60
									+S	-s	Ag	7440-22-4		0.25	mg			15,000
+1 -1	Mold Compound	+M -M	G631H	21.5	mg	+C	Supplier		+S	-s	Carbon Black	1333-86-4		0.07	mg			3,000
									+S	-s	Epoxy Resin	Trade Secre		1.29	mg			60,000
									+S	-s	Phenol Resin	Trade Secre		1.075	mg			50,000
									+S	-S	Silica Fused	60676-86-0		19.08	mg			887,00
+ -	Wire	+M -M	Cu Wire	0.1	mg	+C -C	Supplier		+S ·	-s	Cu	7440-50-8		0.1	mg		-	978,00
							-	•	+S	-s	Palladium	7440-05-3		0	mg			21,000
									+S	-s	Gold	7440-57-1		0	mg			100